

Product Summary (@ T_A = +25°C, Per Leg)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V)	I _{R(MAX)} (mA)
60	15	0.6	0.5

Description and Applications

- SMPS
- DC-DC converter
- Freewheeling Diodes

Features and Benefits

- Low Forward Voltage Drop
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- UL Approval in Accordance with UL 1557, Reference No.E94661
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Also Available in Green Molding Compound (Note 4)**

Mechanical Data

- Case: TO-220AB, ITO-220AB
- Case Material: Molded Plastic.
UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
Solderable per MIL-STD-202, Method 208 Ⓔ3
- Weight: TO-220AB – 1.85 grams (Approximate)
ITO-220AB – 1.65 grams (Approximate)



TO-220AB
Top View



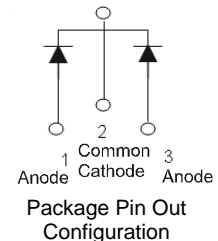
TO-220AB
Bottom View



ITO-220AB
Top View



ITO-220AB
Bottom View

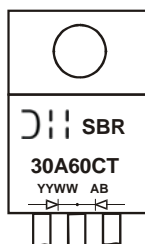


Ordering Information (Notes 4 & 5)

	Part Number	Case	Packaging
	SBR30A60CT	TO-220AB	50 pieces/tube
	SBR30A60CT-G	TO-220AB	50 pieces/tube
	SBR30A60CTFP	ITO-220AB	50 pieces/tube
	SBR30A60CTFP-G	ITO-220AB	50 pieces/tube
	SBR30A60CTFP-JT	ITO-220AB (Alternate)	50 pieces/tube

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For Green Molding Compound version part numbers, refer to the Green symbol next to part number.
 5. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



SBR30A60CT = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 14 = 2014)
 WW = Week (01 - 53)



SBR30A60CTFP = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 14 = 2014)
 WW = Week (01 - 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	60	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
Average Rectified Output Current	I _O	30	A
Non-Repetitive Avalanche Energy (T _J = +25°C, I _{AS} = 20A, L = 8.5mH, t _p = 1ms)	E _{AS}	400	mJ
Repetitive Peak Avalanche Energy (1μs, +25°C)	P _{ARM}	8,600	W
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	250	A
Peak Repetitive Reverse Surge Current (2μs - 1KHz)	I _{RRM}	3	A
Isolation Voltage (ITO-220AB Only) From Terminal to Heatsink t = 3 sec.	V _{AC}	2,000	V

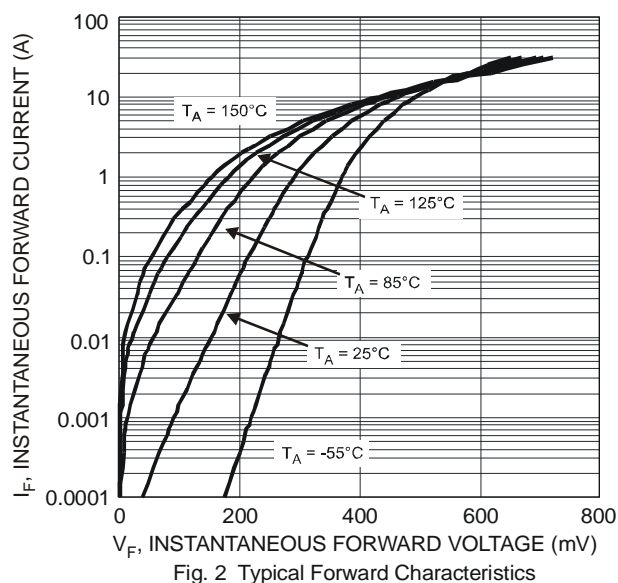
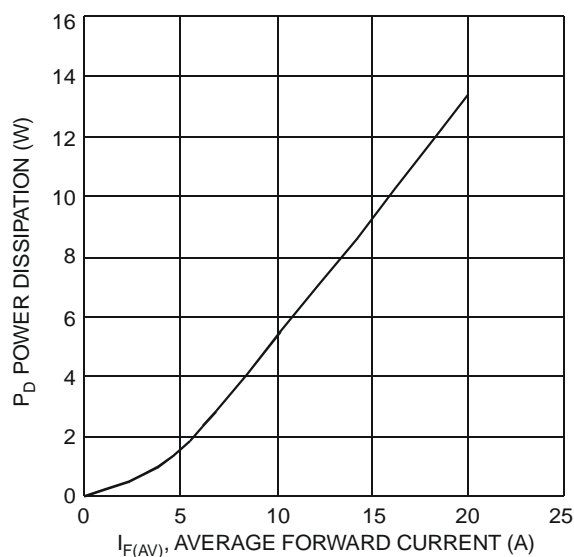
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance			
Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	10.6	°C/W
Thermal Resistance Junction to Case (Note 6)	R _{θJC}	2	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	-	- 0.53	0.60 0.55	V	I _F = 15A, T _J = +25°C I _F = 15A, T _J = +125°C
Leakage Current (Note 7)	I _R	-	-	0.5 60	mA	V _R = 60V, T _J = +25°C V _R = 60V, T _J = +125°C

Notes: 6. Test Device on Heatsink (Black Aluminum, 50mm x 50mm x 23mm).
 7. Short duration pulse test used to minimize self-heating effect.



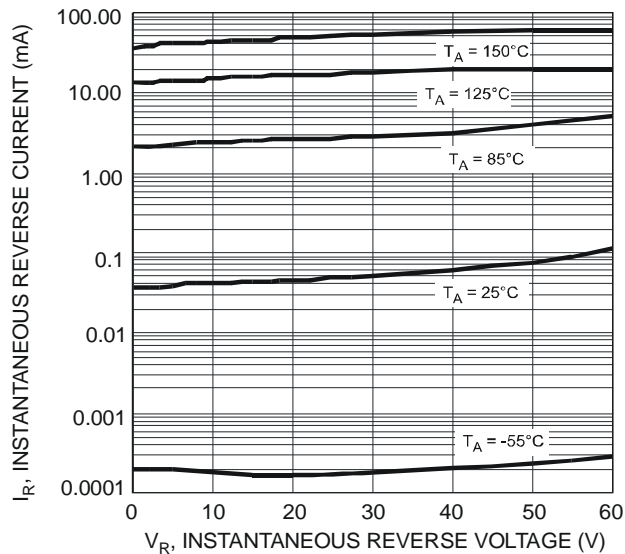


Fig. 3 Typical Reverse Characteristics

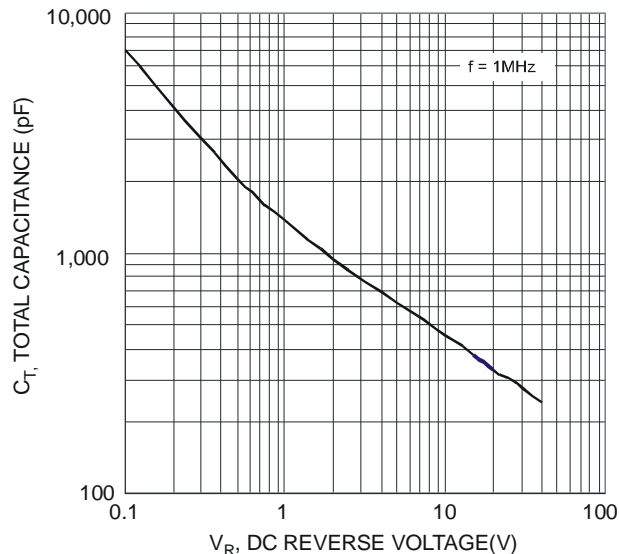


Fig. 4 Total Capacitance vs. Reverse Voltage

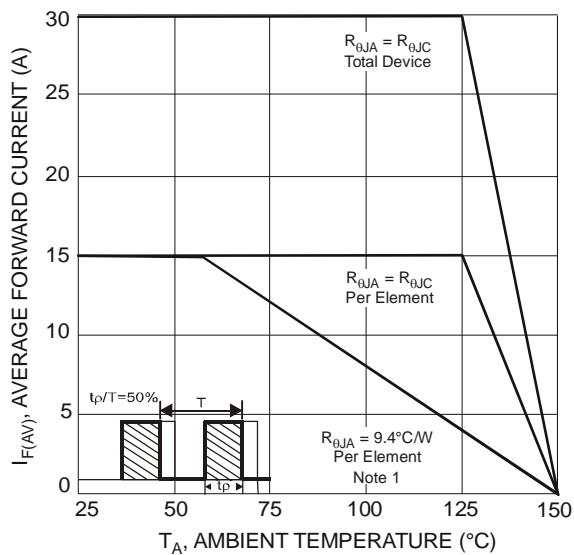


Fig. 5 Forward Current Derating Curve

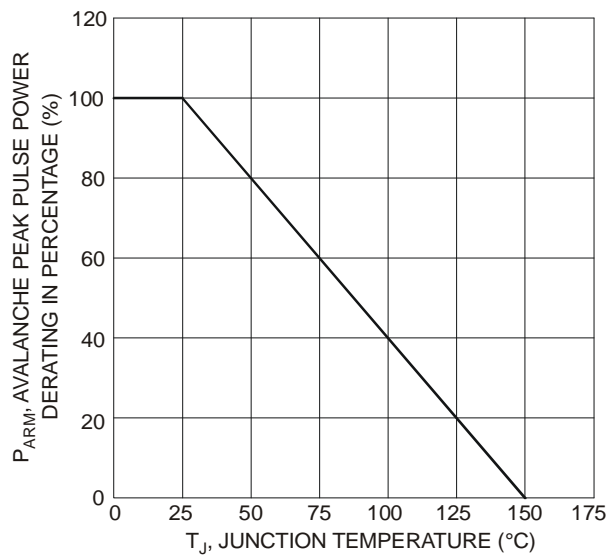


Fig. 6 Pulse Derating Curve

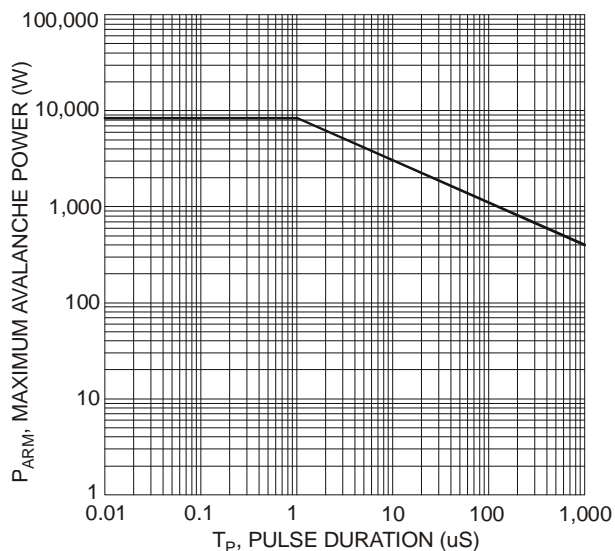
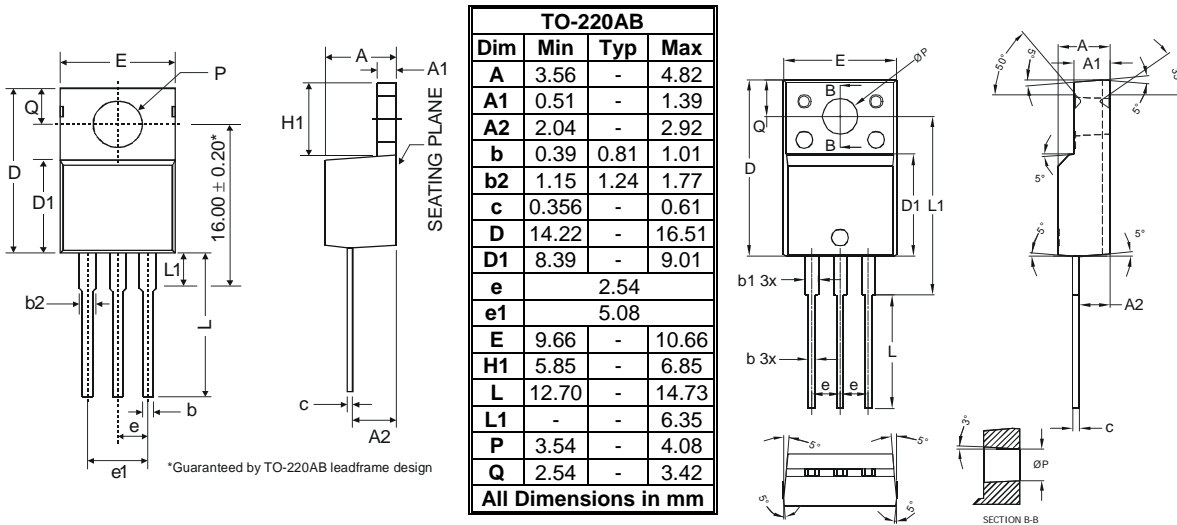


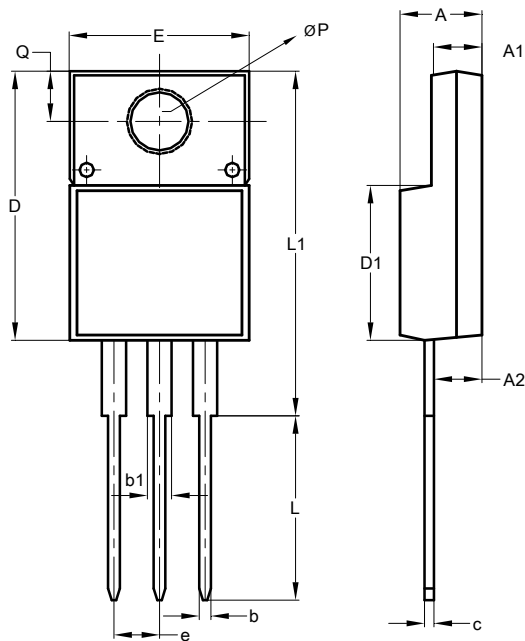
Fig. 7 Maximum Avalanche Power Curve

Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



ITO-220AB			
Dim	Min	Typ	Max
A	4.50	4.70	4.90
A1	3.04	3.24	3.44
A2	2.56	2.76	2.96
b	0.50	0.60	0.75
b1	1.10	1.20	1.35
c	0.50	0.60	0.70
D	15.67	15.87	16.07
D1	8.99	9.19	9.39
e	2.54		
E	9.91	10.11	10.31
L	9.45	9.75	10.05
L1	15.80	16.00	16.20
P	2.98	3.18	3.38
Q	3.10	3.30	3.50
All Dimensions in mm			



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